DISCRETE SEMICONDUCTORS

DATA SHEET

BUW84; BUW85Silicon diffused power transistors

Product specification Supersedes data of February 1996 File under Discrete Semiconductors, SC06 1997 Aug 14





Silicon diffused power transistors

BUW84; **BUW85**

DESCRIPTION

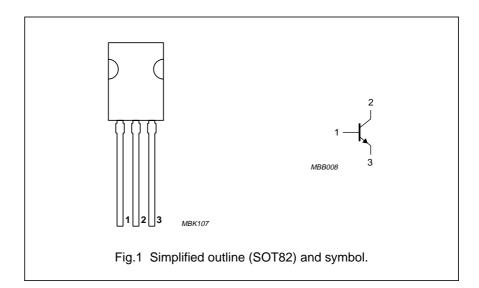
High-voltage, high-speed, glass-passivated NPN power transistor in a SOT82 package.

APPLICATIONS

- Converters
- Inverters
- Switching regulators
- Motor control systems
- Switching applications.

PINNING

PIN	DESCRIPTION
1	base
2	collector; connected to mounting base
3	emitter



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0$			
	BUW84		_	800	V
	BUW85		_	1000	V
V _{CEO}	collector-emitter voltage	open base			
	BUW84		_	400	V
	BUW85		_	450	V
V _{CEsat}	collector-emitter saturation voltage	I _C = 1 A; I _B = 200 mA; see Fig.7	_	1	V
I _C	collector current (DC)	see Figs 4 and 5	_	2	А
I _{CM}	collector current (peak value)	see Figs 4 and 5	_	3	А
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; see Fig.8	_	50	W
t _f	fall time	resistive load; see Fig.11	0.4	_	μs

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	2.1	K/W
R _{th j-a}	thermal resistance from junction to ambient in free air	100	K/W

Silicon diffused power transistors

BUW84; BUW85

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CESM}	collector-emitter peak voltage	V _{BE} = 0			
	BUW84		_	800	V
	BUW85		_	1000	V
V _{CEO}	collector-emitter voltage	open base			
	BUW84		_	400	V
	BUW85		_	450	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)	see Figs 4 and 5	_	2	Α
I _{CM}	collector current (peak value)	t _p = 2 ms; see Figs 4 and 5	_	3	Α
I _B	base current (DC)		_	0.75	Α
I _{BM}	base current (peak value)		_	1	Α
I _{BM}	base current (reversed; peak value)	turn-off current	_	-1	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; see Fig.8	_	50	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

CHARACTERISTICS

 T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CEOsust}	collector-emitter sustaining voltage BUW84	I _C = 100 mA; I _{Boff} = 0; L = 25 mH; see Figs 2 and 3	400	_	_	V
	BUW85		450	_	-	V
V _{CEsat}	collector-emitter saturation voltage	$I_C = 0.3 \text{ A}; I_B = 30 \text{ mA};$ see Fig.7	_	_	0.8	V
		I _C = 1 A; I _B = 200 mA; see Fig.7	_	_	1	V
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 200 mA	_	_	1.1	V
I _{CES}	collector-emitter cut-off current	V _{CEM} = V _{CEMSmax} ; V _{BE} = 0; note 1	_	_	200	μΑ
		$V_{CEM} = V_{CEMSmax}$; $V_{BE} = 0$; $T_j = 125$ °C; note 1	_	_	1.5	mA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	_	1	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ A}; \text{ see Fig.10}$	15	_	_	
		V_{CE} = 5 V; I_{C} = 100 mA; see Fig.10	20	50	100	
f _T	transition frequency	V _{CE} = 10 V; I _C = 200 mA; f = 1 MHz	_	20	_	MHz

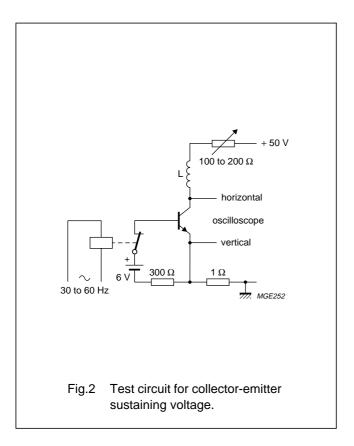
Silicon diffused power transistors

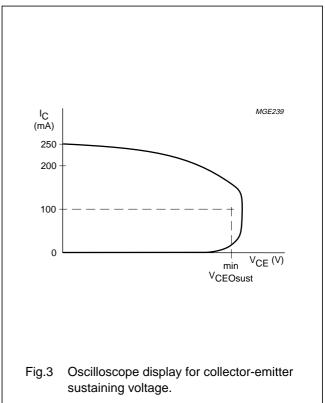
BUW84; BUW85

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Switching	times in horizontal deflection circuit	t (see Fig.11)				
t _{on}	turn-on time	I _{Con} = 1 A; I _{Bon} = 200 mA; I _{Boff} = -400 mA; V _{CC} = 250 V	_	0.2	0.5	μs
t _s	storage time	I _{Con} = 1 A; I _{Bon} = 200 mA; I _{Boff} = -400 mA; V _{CC} = 250 V	_	2	3.5	μs
t _f	fall time	I _{Con} = 1 A; I _{Bon} = 200 mA; I _{Boff} = -400 mA; V _{CC} = 250 V	_	0.4	_	μs
		$I_{Con} = 1 \text{ A; } I_{Bon} = 200 \text{ mA;}$ $I_{Boff} = -400 \text{ mA; } V_{CC} = 250 \text{ V;}$ $I_{mb} = 95 \text{ °C}$	-	-	1.4	μs

Note

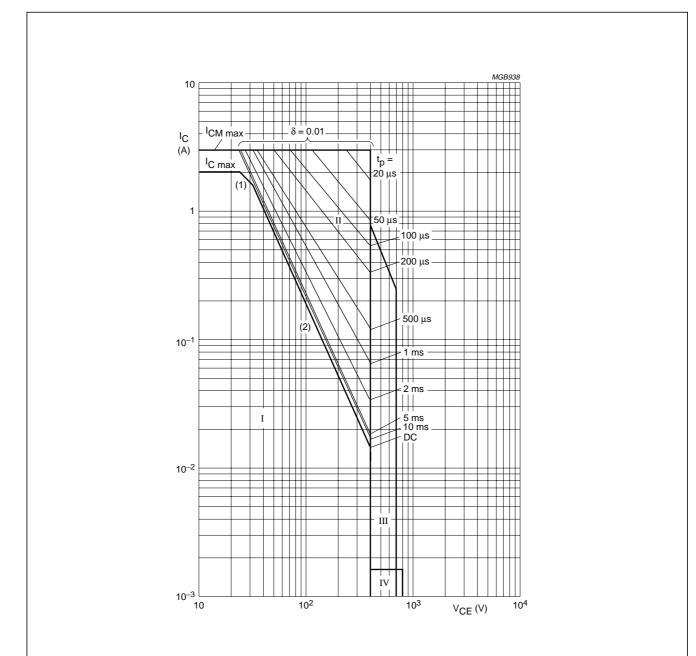
1. Measured with a half-sinewave voltage (curve tracer).





Silicon diffused power transistors

BUW84; BUW85



BUW84.

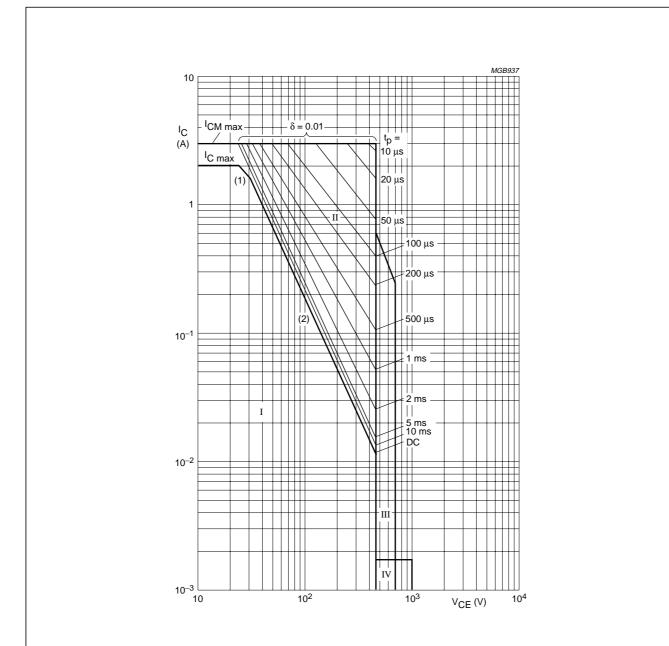
 $T_{mb} \le 25 \, ^{\circ}C$.

- I Region of permissible DC operation.
- II Permissible extension for repetitive pulse operation.
- III Area of permissible operation during turn-on in single transistor converters, provided $R_{BE} \le 100~\Omega$ and $t_0 \le 0.6~\mu s$.
- IV Repetitive pulse operation in this region is permissible provided $V_{BE} \leq 0$ and $t_p \leq 2$ ms.
- (1) P_{tot max} line.
- (2) Second breakdown limits.

Fig.4 Forward bias SOAR.

Silicon diffused power transistors

BUW84; BUW85



BUW85.

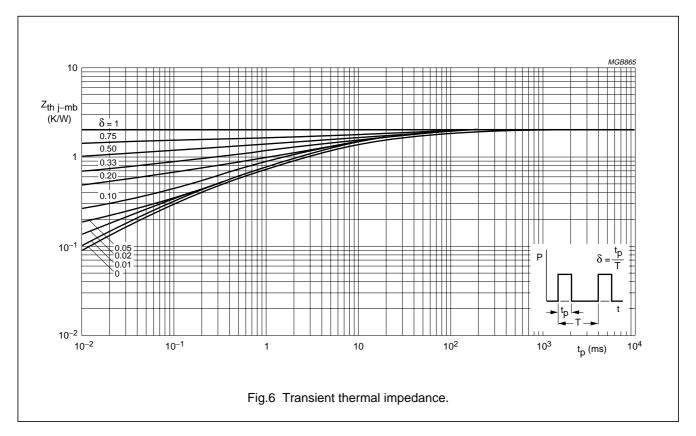
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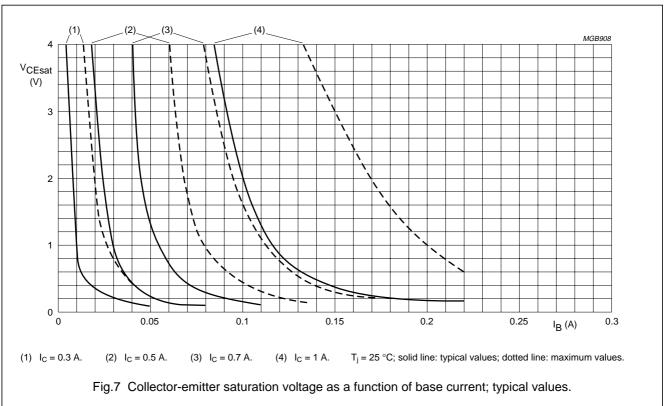
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- (1) P_{tot max} line.
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Fig.5 Forward bias SOAR.

Silicon diffused power transistors

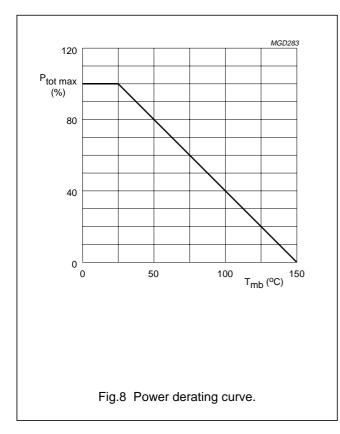
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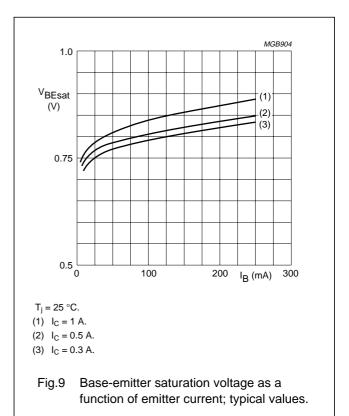


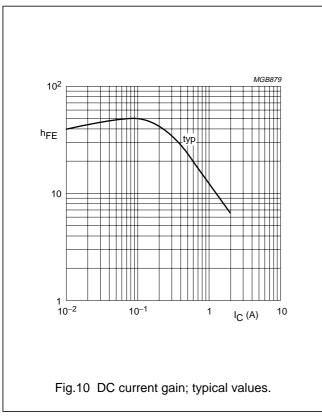


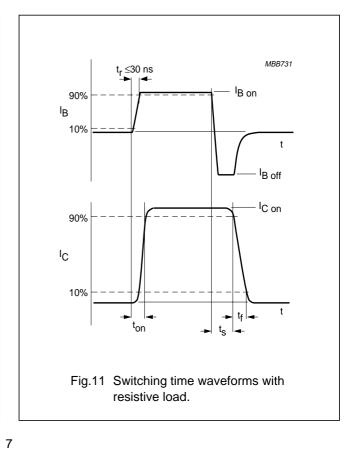
Silicon diffused power transistors

BUW84; BUW85





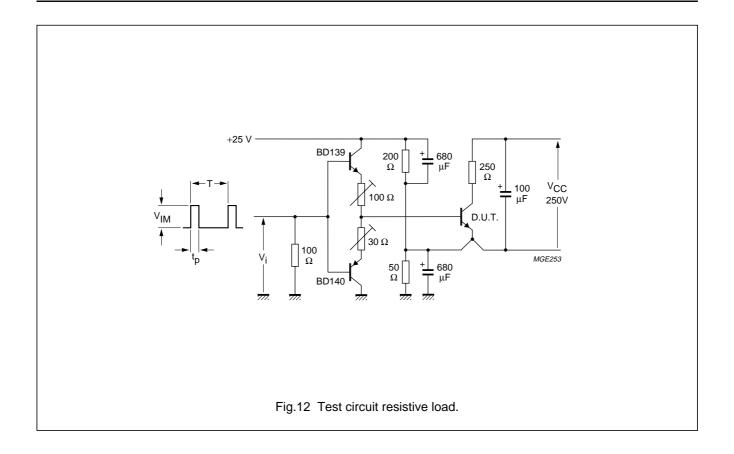




1997 Aug 14

Silicon diffused power transistors

BUW84; BUW85



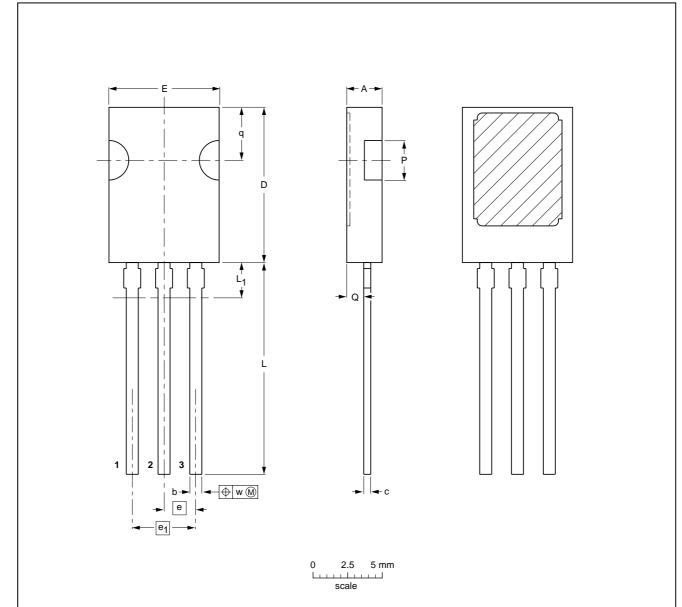
Silicon diffused power transistors

BUW84; BUW85

PACKAGE OUTLINE

Plastic single-ended package; 3 leads (in-line)

SOT82



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	С	D	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	Р	Q	q	w
mm	2.8 2.3	0.88 0.65	0.58 0.47	11.1 10.5	7.8 7.2	2.29	4.58	16.5 15.3	2.54	3.1 2.5	1.5 0.9	3.9 3.5	0.254

Note

1. Terminal dimensions within this zone are uncontrolled to allow for body and terminal irregularities.

OUTLINE		REFER	EUROPEAN ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT82				$ \ \ \bigoplus \big($	97-06-11

Silicon diffused power transistors

BUW84; **BUW85**

DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or					

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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Printed in The Netherlands

137067/00/01/pp12

Date of release: 1997 Aug 14

Document order number: 9397 750 02722

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